

### Description

#### Features

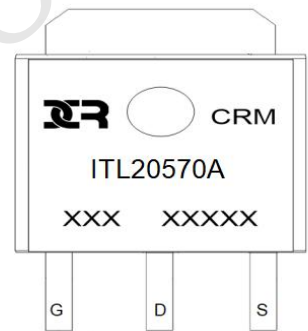
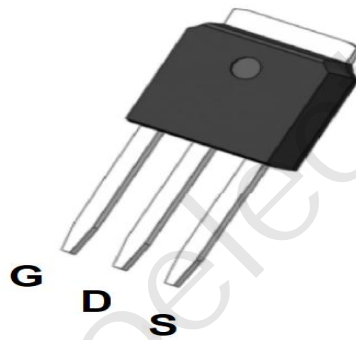
- 200V, 5A  
 $R_{DS(ON)}$  Typ = 478mΩ @  $V_{GS} = 10V$   
 Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS TESTED!
- 100%  $\Delta V_{ds}$  TESTED!



Schematic Diagram

#### Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

#### Package Marking and Ordering Information

| Device       | Marking      | Package   | Outline | TUBE(pcs) | Inner Box (pcs) | Per Carton (pcs) |
|--------------|--------------|-----------|---------|-----------|-----------------|------------------|
| CRMITL20570A | CRMITL20570A | TO-251-3L | TUBE    | 72        | 4320            | 21600            |

#### Absolute Maximum Ratings (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol          | Parameter                                     | Value                     | Units |
|-----------------|---|---------------------------|-------|
| $V_{DS}$        | Drain-to-Source Voltage                       | 200                       | V     |
| $V_{GS}$        | Gate-to-Source Voltage                        | ±20                       | V     |
| $I_D$           | Continuous Drain Current                      | $T_C = 25^\circ\text{C}$  | 5 A   |
|                 |   | $T_C = 100^\circ\text{C}$ | 3 A   |
| $I_{DM}$        | Pulsed Drain Current <sup>(1)</sup>           | 20                        | A     |
| $E_{AS}$        | Single Pulsed Avalanche Energy <sup>(2)</sup> | 26.5                      | mJ    |
| $P_D$           | Power Dissipation                             | $T_C = 25^\circ\text{C}$  | 35 W  |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case          | 3.6                       | °C/W  |
| $T_J, T_{STG}$  | Junction & Storage Temperature Range          | -55 to 150                | °C    |

### Electrical Characteristics ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|------------|------|------|------|------|
|--------|-----------|------------|------|------|------|------|

#### Off Characteristics

|               |                                 |   |     |   |           |               |
|---------------|---------------------------------|---|-----|---|-----------|---------------|
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage  | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$    | 200 | - | -         | V             |
| $I_{DSS}$     | Zero Gate Voltage Drain Current | $V_{DS} = 200\text{V}, V_{GS} = 0\text{V}$    | -   | - | 1.0       | $\mu\text{A}$ |
| $I_{GSS}$     | Gate-Body Leakage Current       | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$ | -   | - | $\pm 100$ | nA            |

#### On Characteristics

|              |  |   |     |     |     |    |
|--------------|--|---|-----|-----|-----|----|
| $V_{GS(th)}$ | Gate Threshold Voltage                           | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 1.2 | 1.8 | 2.4 | V  |
| $R_{DS(ON)}$ | Static Drain-Source ON-Resistance <sup>(3)</sup> | $V_{GS} = 10\text{V}, I_D = 3\text{A}$  | -   | 478 | 573 | mΩ |

#### Dynamic Characteristics

|           |                              |  |   |     |   |    |
|-----------|------------------------------|--|---|-----|---|----|
| $C_{iss}$ | Input Capacitance            | $V_{GS} = 0\text{V}, V_{DS} = 25\text{V},$<br>$f = 1\text{MHz}$                | - | 625 | - | pF |
| $C_{oss}$ | Output Capacitance           |  | - | 32  | - | pF |
| $C_{rss}$ | Reverse Transfer Capacitance |  | - | 23  | - | pF |
| $Q_g$     | Total Gate Charge            | $V_{GS} = 0 \text{ to } 10\text{V}$<br>$V_{DS} = 100\text{V}, I_D = 1\text{A}$ | - | 12  | - | nC |
| $Q_{gs}$  | Gate Source Charge           |  | - | 2.5 | - | nC |
| $Q_{gd}$  | Gate Drain("Miller") Charge  |  | - | 3.8 | - | nC |

#### Switching Characteristics

|              |                     |   |   |    |   |    |
|--------------|---------------------|---|---|----|---|----|
| $t_{d(on)}$  | Turn-On Delay Time  | $V_{GS} = 10\text{V}, V_{DD} = 100\text{V}$<br>$I_D = 1\text{A}, R_{GEN} = 2.5\Omega$ | - | 10 | - | ns |
| $t_r$        | Turn-On Rise Time   |   | - | 12 | - | ns |
| $t_{d(off)}$ | Turn-Off Delay Time |   | - | 15 | - | ns |
| $t_f$        | Turn-Off Fall Time  |   | - | 15 | - | ns |

#### Drain-Source Diode Characteristics and Max Ratings

|          |  |                                       |   |    |     |    |
|----------|--|---------------------------------------|---|----|-----|----|
| $I_S$    | Maximum Continuous Drain to Source Diode Forward Current | $V_{GS} = 0\text{V}, I_S = 3\text{A}$ | - | -  | 5   | A  |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current     |                                       | - | -  | 20  | A  |
| $V_{SD}$ | Drain to Source Diode Forward Voltage                    |                                       | - | -  | 1.2 | V  |
| $t_{rr}$ | Body Diode Reverse Recovery Time                         |                                       | - | 50 | -   | ns |
| $Q_{rr}$ | Body Diode Reverse Recovery Charge                       |                                       | - | 98 | -   | nC |

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 50\text{V}$ ,  $V_G = 10\text{V}$ ,  $R_G = 25\Omega$ ,  $L = 10\text{mH}$ ,  $I_{AS} = 2.3\text{A}$
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Test Circuit

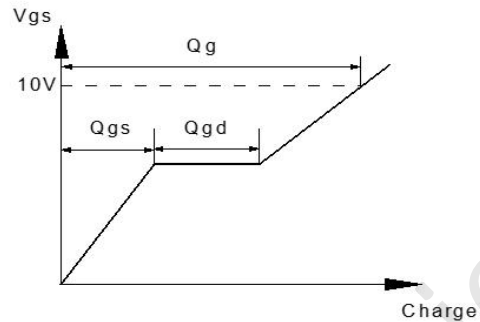


Figure 1: Gate Charge Test Circuit & Waveform

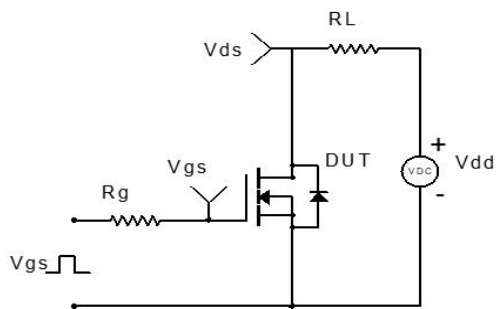


Figure 2: Resistive Switching Test Circuit & Waveform

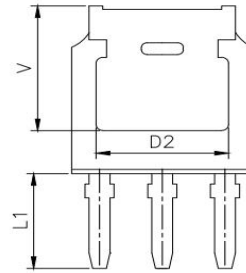
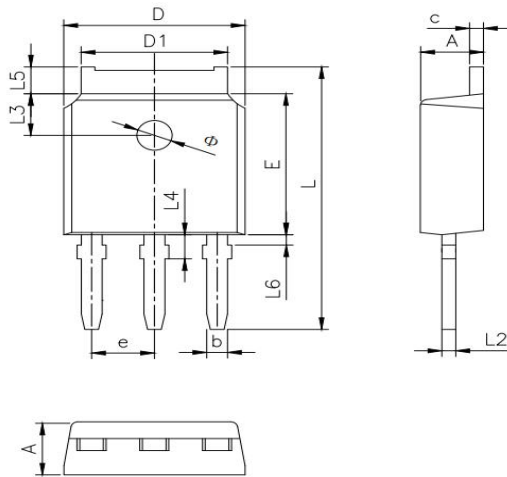


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform



Figure 4: Diode Recovery Test Circuit & Waveform

### Package Mechanical Data(TO-251-3L)




| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 2.20       | 2.30  | 2.40  |
| b      | 0.66       | 0.76  | 0.86  |
| c      | 0.46       | 0.51  | 0.58  |
| D      | 6.50       | 6.60  | 6.70  |
| D1     | 5.10       | 5.33  | 5.46  |
| D2     | 4.83 REF.  |       |       |
| E      | 6.00       | 6.10  | 6.20  |
| e      | 2.19       | 2.29  | 2.39  |
| L      | 11.02      | 11.22 | 11.42 |
| L1     | 4.10 REF.  |       |       |
| L2     | 0.508BSC   |       |       |
| L3     | 1.80 REF.  |       |       |
| L4     | 0.95       | 1.05  | 1.15  |
| L5     | 0.90       | —     | 1.25  |
| L6     | 0.15       | —     | 0.75  |
| Φ      | 1.10       | —     | 1.30  |
| V      | 5.40 REF.  |       |       |

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